## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Mutsuhiro OHMORI	12/15/2005
Tomohiro TSUNODA	12/19/2005
Shigehiro SHIMADA	12/21/2005

#### **RECEIVING PARTY DATA**

Name:	SONY CORPORATION	
Street Address:	7-35, Kitashinagawa 6-chome, Shinagawa-ku,	
City:	Tokyo	
State/Country:	JAPAN	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	10566472

# **CORRESPONDENCE DATA**

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Angela Whirley

Total Attachments: 2

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PATENT REEL: 020078 FRAME: 0916 \$40.00 1056

ASSIGNM	Docket Number:
ASSIGNM	IEN I
WHEREAS, I, as a below named inventor, residing only one name is listed below) or a joint inventor (if plural names a INFORMATION PROCESSING DEVICE AND METHOD, PROGR	ng at the address stated next to my name, am a sole inventor (if are listed below) of certain new and useful improvements in RAM, AND RECORDING MEDIUM
for which application for Letters Patent of the United States of Ame	rice was executed by me on the date indicated next to my name
for which application for Letters Patent of the United States of Affice and address;	inca was executed by the on the date indicated next to my hame
AND WHEREAS, Sony Corporation, a Japanes Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is said application disclosing the invention and in, to and under any I therefor in the United States and in any and all foreign countries;	se corporation with offices at 7-35 Kitashinagawa 6-Chome, is desirous of acquiring all interest in, to and under said invention, Letters Patent or similar legal protection which may be granted
NOW THEREFORE, in consideration of the sum of the receipt and sufficiency of which are hereby acknowledged, I, as hereby assign, sell and transfer unto the said ASSIGNEE, its success interest in the said invention, said application, including any division Patent of the United States, and countries foreign thereto, which may rights and/or convention rights under the International Convention for Relating to Patents, Designs and Industrial Models, and any other is adheres, and to any other benefits accruing or to accrue to me with patents in the United States and countries foreign thereto, and I herebisaid United States Letters Patent to said ASSIGNEE, as the assigned	sors, assigns, and legal representatives, the entire right, thre and ons and continuations thereof, and in and to any and all Letters be granted for said invention, and in and to any and all priority the Protection of Industrial Property, Inter-American Convention international agreements to which the United States of American respect to the filing of applications for patents or securing of any authorize and request the Commissioner of Patents to issue the
ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and without further remuneration, in order to perfect title in said applications and Letters Patent of the United States and countries for	invention, modifications, and improvements in said invention, preign thereto;
And I further agree to properly execute and deliver and with papers for application for foreign patents, for filing subdivisions of reissues of any Letters Patent which may be granted for my aforesaid prepare at its own expense;	nout further remuneration, such necessary or desirable and lawful said application for patent, and or, for obtaining any reissue or invention, as the ASSIGNEE thereof shall hereafter require and
And I further agree that ASSIGNEE will, upon its request relating to said application, said invention and said Letters Patent a accessible to me and will testify as to the same in any interference	t, be provided promptly with all pertinent facts and documents and legal equivalents in foreign countries as may be known and or litigation related thereto;
And I hereby covenant that no assignment, sale, agreement would conflict with this assignment and sale.	or encumbrance has been or will be made or entered into which
And I hereby authorize and request my attorney(s) of record this application in the spaces that follow: International Application No.:	d in this application to insert the serial number and filing date of PCT/JP2004/011160ernational Filing Date August 4, 2004
This assignment executed on the dates indicated below.	
Mutsuhiro OHMORI	December 15, 2005  Execution date of U.S. Patent Application
Name of first or sole inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of first or sole inventor	
mutsukiro Ohmori	Pecember 15, 2005  Date of this assignment
Signature of first or sole inventor	Date of this assignment

PATENT REEL: 020078 FRAME: 0917

Tomohiro TSUNODA	December 19, 2005 Execution date of U.S. Patent Application
Name of second inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of second inventor	
Monohin Buroda Signature of second inventor	December 19, 2005  Date of this assignment
Signature of second inventor	Date of this assignment
Shigehiro SHIMADA	December 21, 2005 Execution date of U.S. Patent Application
Name of third inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of third inventor	
Signature of third inventor	December 21, 2005  Date of this assignment
Signature of third inventor	Date of this assignment
Name of fourth inventor	Execution date of U.S. Patent Application
Name of fourth inventor	
Residence of fourth inventor	
Signature of fourth inventor	Date of this assignment
Name of fifth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	
Signature of fifth inventor	Date of this assignment

**RECORDED: 11/07/2007** 

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